R8C/35C Group

I^2C bus Single Master Control Program (Slave Transmit/Receive)

R01AN0075EJ0100
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1. Abstract

This document describes the slave transmit/receive processes in the I^2C bus single master control program using the R8C/35C Group I^2C bus interface.

2. Introduction

The application example described in this document applies to the following microcomputer (MCU) and parameter:

- MCU: R8C/35C Group
- XIN Clock: 20 MHz

This application note can be used with other R8C Family MCUs which have the same special function registers (SFRs) as the above group. Check the manual for any modifications to functions. Careful evaluation is recommended before using the program described in this application note.

3. Application Example

3.1 Program Outline

Use the I2C bus interface to perform serial communication. A maximum of 255 bytes of data can be transmitted and received. This communication procedure conforms to the I2C bus communication protocol when used under the following conditions:

- Slave address: 7 bits
- Standard-mode and Fast-mode are supported.
- Transfer data length: 1 to 255 bytes (not including the slave address)
- Restart condition detection is not supported.

Figure 3.1 shows the Communication Format, Figure 3.2 shows the Block Diagram, Figure 3.3 shows the Outline Flowchart, and Figure 3.4 to Figure 3.6 show Timing Diagrams.

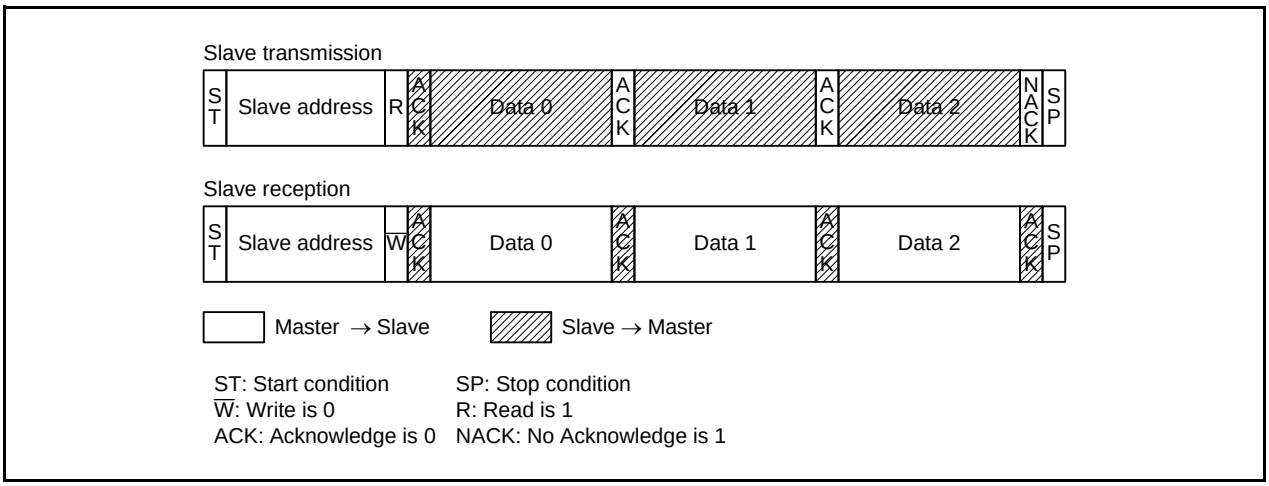


Figure 3.1 Communication Format

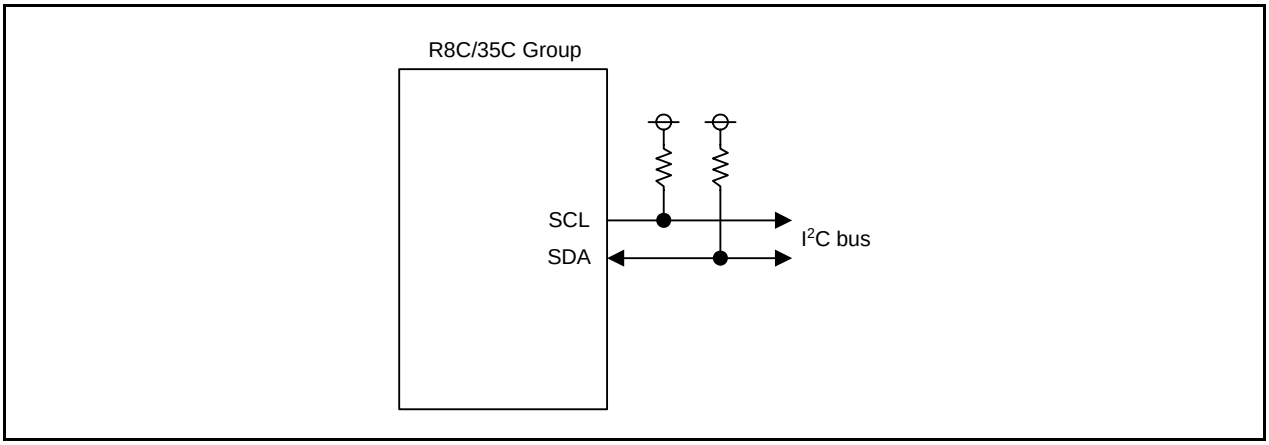


Figure 3.2 Block Diagram

The numbers in Figure 3.3 correspond to the numbers indicated in the program processing in the operating timing charts in Figure 3.4 to Figure 3.6.

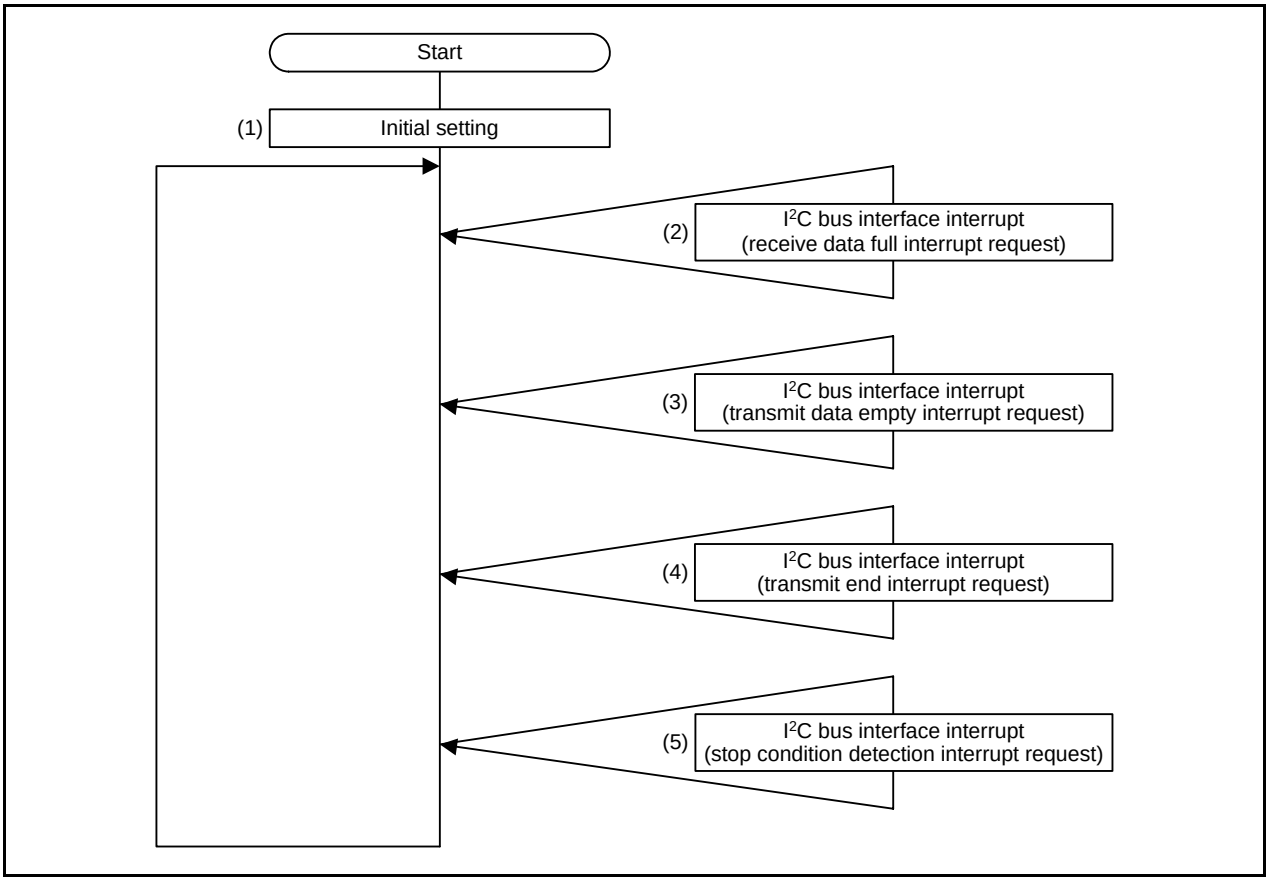


Figure 3.3 Outline Flowchart

A description of the process outline is as follows:

(1) Initial setting
Initialize the system clock, I²C bus interface associated SFRs, and variables used.

(2) I²C bus interface interrupt (receive data full interrupt request)
Before the slave address is matched:
When the following conditions are met, an interrupt is generated at the rising edge of the ninth bit of the SCL clock.
• The slave address is matched at the first byte after a start condition is detected.
• The data at the eighth byte (R/$\overline{W}$) is 0.
After the slave address is matched:
An interrupt is generated at the rising edge of the ninth bit of the SCL clock. The received data is stored at reception.

(3) I²C bus interface interrupt (transmit data empty interrupt request)
When the following conditions are met, an interrupt is generated at the rising edge of the ninth bit of the SCL clock.
• The slave address is matched at the first byte after a start condition is detected.
• The data at the eighth byte (R/$\overline{W}$) is 1.
Disable the transmit data empty interrupt request and receive data full interrupt request. Enable the transmit end interrupt request.

(4) I²C bus interface interrupt (transmit end interrupt request)
An interrupt is generated at the rising edge of the ninth bit of the SCL clock. Determine ACK/NACK and set the transmit data for the next byte.
When NACK is detected:
• Set the TRS bit in the ICCR1 register to receive mode.
• Disable the transmit end interrupt request and enable the receive data full interrupt request.

(5) I²C bus interface interrupt (stop condition detection interrupt request)
An interrupt is generated when a stop condition is detected. Disable the stop condition detection interrupt request. Set the TRS bit to receive mode, enable the transmit data empty interrupt request, and receive the data full interrupt request.

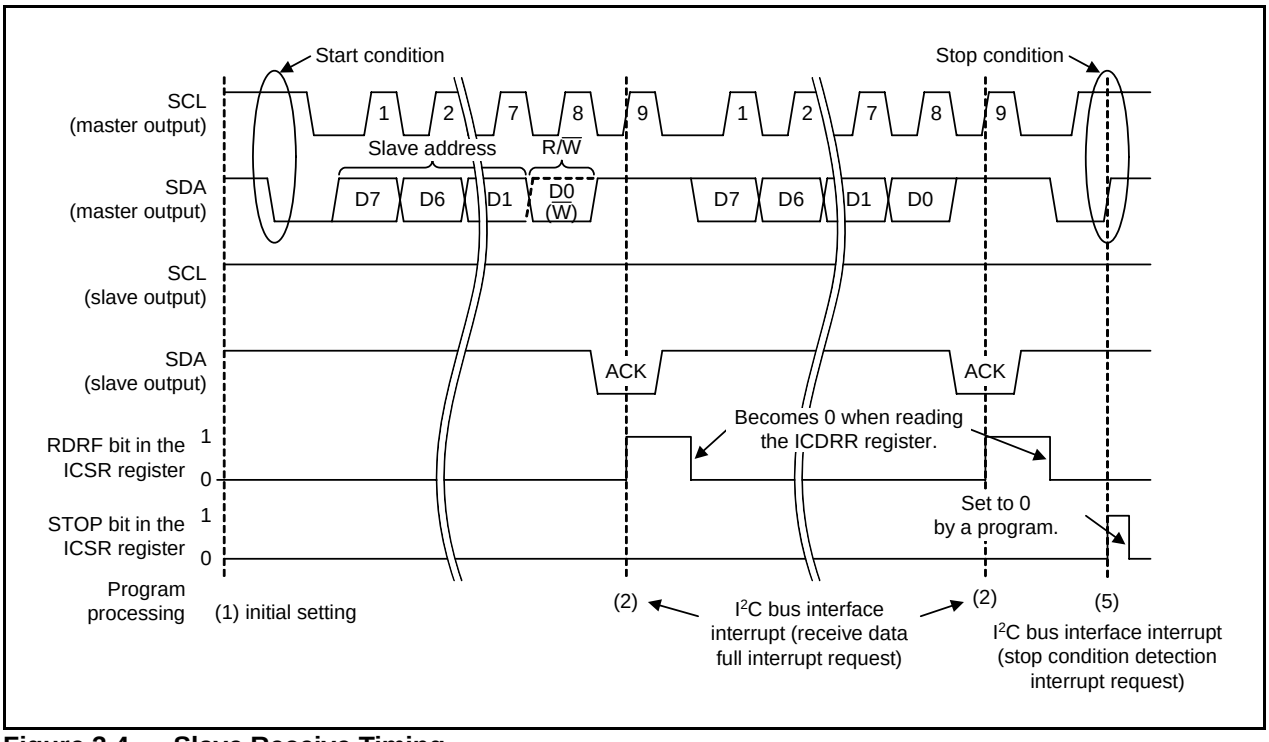


Figure 3.4 Slave Receive Timing

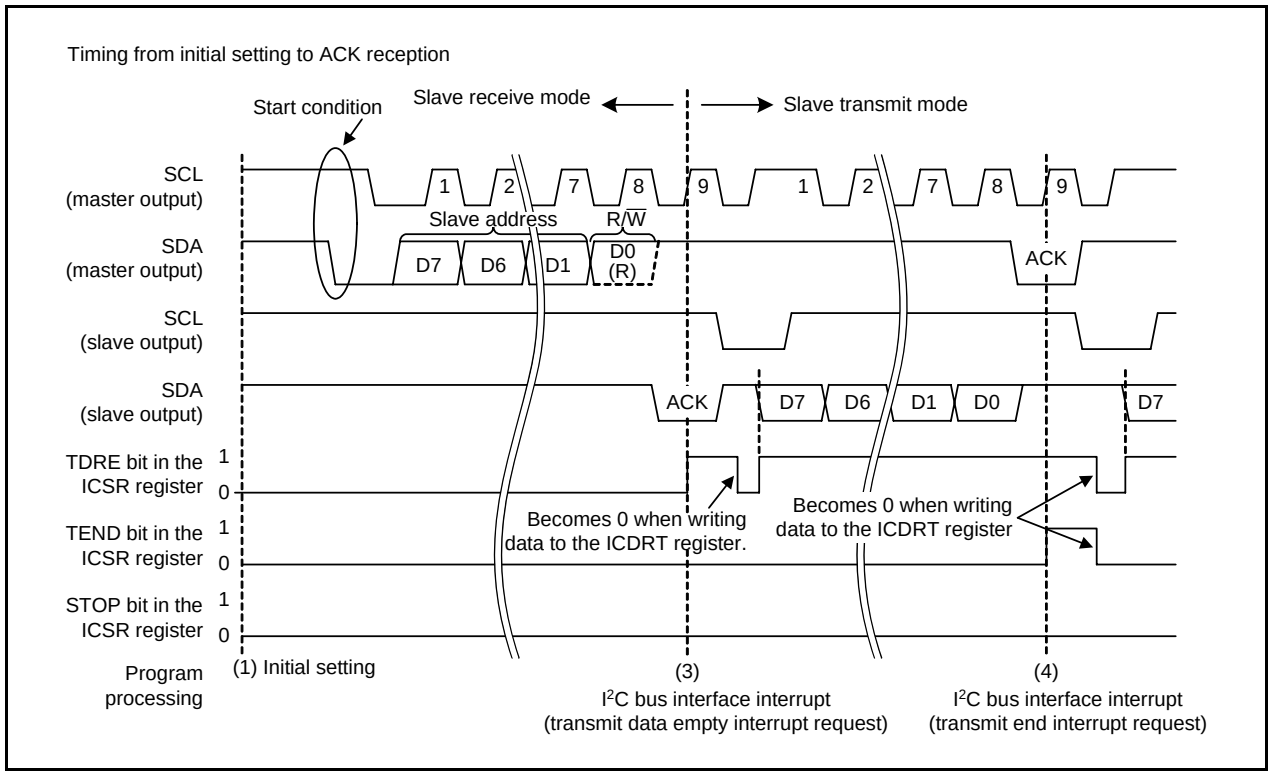


Figure 3.5 Slave Transmit Timing (1)

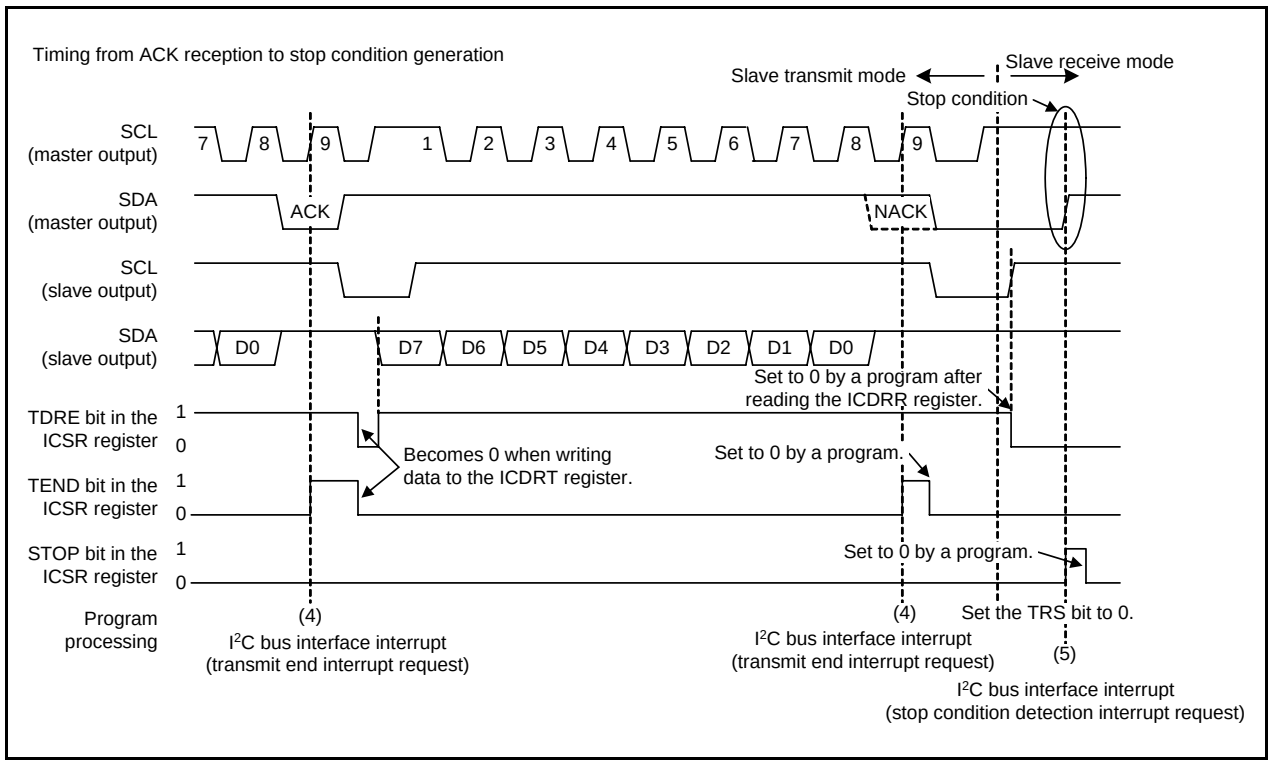


Figure 3.6 Slave Transmit Timing (2)

3.1.1 Peripheral Functions

The I2C bus interface mode of the I2C bus interface is used under the following setting conditions:

- I2C bus format is used.
- MSB first is used for the transfer format.
- No wait states are set (data and the acknowledge bit are transferred consecutively).
- 20 Tcyc is selected for the setup time in transmit mode.
- 3 × f1 cycles are used for the SDA digital delay value.
- The ACKBR bit in the ICIER register is used to determine an acknowledge signal.
- The AAS bit in the ICSR register is used to detect the slave address.
- The receive data full interrupt request is used.
- The transmit end interrupt request is used.
- The transmit data empty interrupt request is used.
- The stop condition detection interrupt request is used.
- The NACK receive interrupt request and arbitration lost/overrun error interrupt request are not used.

Calculating the setup time in transmit mode
Setup time = CKS3 bit in the ICCR1 register setting
= 20 ÷ 20 MHz (f1)
= 1 µs

Table 3.1 Pins Used and Their Functions

Pin	I/O	Function
P3_5/SCL	I/O	I2C bus clock I/O pin
P3_7/SDA	I/O	I2C bus data I/O pin

3.1.2 Notes on Using the Attached Sample Program

Note the following when using the program included with this application note:

- Do not use multiple interrupts.
- When setting the system clock to anything other than the 20 MHz XIN clock, change the setting value of the CKS3 bit according to the setup time calculation shown in **3.1.1 Peripheral Functions**.
- The transmit/receive buffer sizes are set to 255 bytes. Use BUFSIZE in the iic.h file to set the buffer size (1 to 255 bytes).
- After a master generates a stop condition and the slave processing time (1) passes, start the next transmission and reception (generate a start condition).

Note
1. The slave processing time shows the time between the stop condition detection and time to enable the I2C module in the main processing, and depends on a user program. The processing time in the attached sample program is approximately 500 µs.

3.2 Memory

Table 3.2 Memory

Memory	Size	Remarks
ROM	622 bytes	In the iic.c module
RAM	4 bytes	In the iic.c module
Maximum user stack	21 bytes	
Maximum interrupt stack	24 bytes	

Memory size varies depending on the C compiler version and compile options.
The above applies to the following conditions:
C compiler: M16C Series, R8C Family C Compiler V.5.45 Release 01
Compile options: -c -finfo -dir “$(CONFIGDIR)” -R8C

4. Software

This section shows the program example to set the example described in section **3. Application Example**. Refer to the latest **R8C/35C Group** hardware user's manual for details on individual registers.

4.1 Variables

Table 4.1 Definition File Name: r01an0075_src.c

Variable Name	Size	Description
unsigned char iic_tx[BUFSIZE]	255 bytes	Transmit buffer
unsigned char iic_rx[BUFSIZE]	255 bytes	Receive buffer
unsigned char rcv_data[BUFSIZE]	255 bytes	Store received data

Table 4.2 Definition File Name: iic.c

Variable Name		Size /Bit-number	Description
static byte_dt iic_str		—	Structure to store status
Structure member	iic_status	1 byte	All statuses
	iic_rw	b0	R/$\overline{W}$ flag 0: Write ($\overline{W}$) 1: Read (R)
	iic_buf_full	b1	Buffer full flag 0: Less than buffer size 1: Buffer full
	iic_end	b2	Communication end flag 0: Busy (mid-communication) 1: Ready (not mid-communication)
	iic_nack_det	b3	NACK detection flag 0: No NACK detection 1: NACK detection
	—	b7 to b4	Not used (undefined)
unsigned char far *iic_pointer		2 bytes	Transmit/receive buffer pointer
unsigned char iic_index		1 byte	Number of transmit/receive bytes

4.2 Function Tables

Declaration	void main(void)		
Outline	Main processing		
Argument	Argument name		Meaning
	None		—
Variable (global)	Variable name		Contents
	unsigned char iic_tx[BUFSIZE]		Transmit buffer
	unsigned char iic_rx[BUFSIZE]		Receive buffer
	unsigned char rcv_data[BUFSIZE]		Store received data
Returned value	Type	Value	Meaning
	None	—	—
Function	After setting the system clock, enable the I²C module. Use the returned value of the iic_slave_end function to determine the communication state. When communication is completed, perform processing on each status, call the iic_init function, and enable the I²C module.		

Declaration	void mcu_init(void)		
Outline	System clock setting		
Argument	Argument name		Meaning
	None		—
Variable (global)	Variable name		Contents
	None		—
Returned value	Type	Value	Meaning
	None	—	—
Function	This function is called from the main processing. Set the system clock (XIN clock).		

Declaration	void iic_init(unsigned char ini)		
Outline	Initial setting of I²C bus interface		
Argument	Argument name	Meaning	
	unsigned char ini	0: I²C module disabled 1: I²C module enabled	
Variable (global)	Variable name		Contents
	(Structure member) iic_status		All statuses
Returned value	Type	Value	Meaning
	None	—	—
Function	This function is called from the main processing. Initialize SFRs to use the I²C bus interface. When the I²C module is enabled, set iic_status to 00h (all statuses are cleared). Interrupts are disabled by the I flag while this function is being executed.		

Declaration	void _ssuic(void)		
Outline	I²C bus interface interrupt handling		
Argument	Argument name		Meaning
	None		—
Variable (global)	Variable name		Contents
	unsigned char iic_index		Number of transmit/receive bytes
	unsigned char *iic_pointer		Transmit/receive buffer pointer
	(Structure member) iic_status		All statuses
	(Structure member) iic_rw		R/$\overline{W}$ flag
Returned value	Type	Value	Meaning
	None	—	—
Function	An interrupt is generated at the rising edge of the ninth bit of the SCL clock or when a stop condition is detected. When a stop condition is detected: •Call the stp_int function. When a stop condition is not detected: •When the slave address is detected, clear the AAS bit, number of transmit/receive bytes, and all statuses. Disable the transmit data empty interrupt request and enable the stop condition interrupt request. Obtain the buffer address and set the R/$\overline{W}$ flag. •Call the slave_trn_int function at slave transmit and the slave_rcv_int function at slave receive.		

Declaration	unsigned char* iic_get_address(unsigned char rw)		
Outline	Obtain buffer address processing		
Argument	Argument name		Meaning
	unsigned char rw		R/$\overline{W}$ flag
Variable (global)	Variable name		Contents
	None		—
Returned value	Type	Value	Meaning
	unsigned char*	iic_rx	Receive buffer address
		iic_tx	Transmit buffer address
Function	This function is called from the I²C bus interface interrupt handling. Determine the R/$\overline{W}$ flag and return the buffer address.		

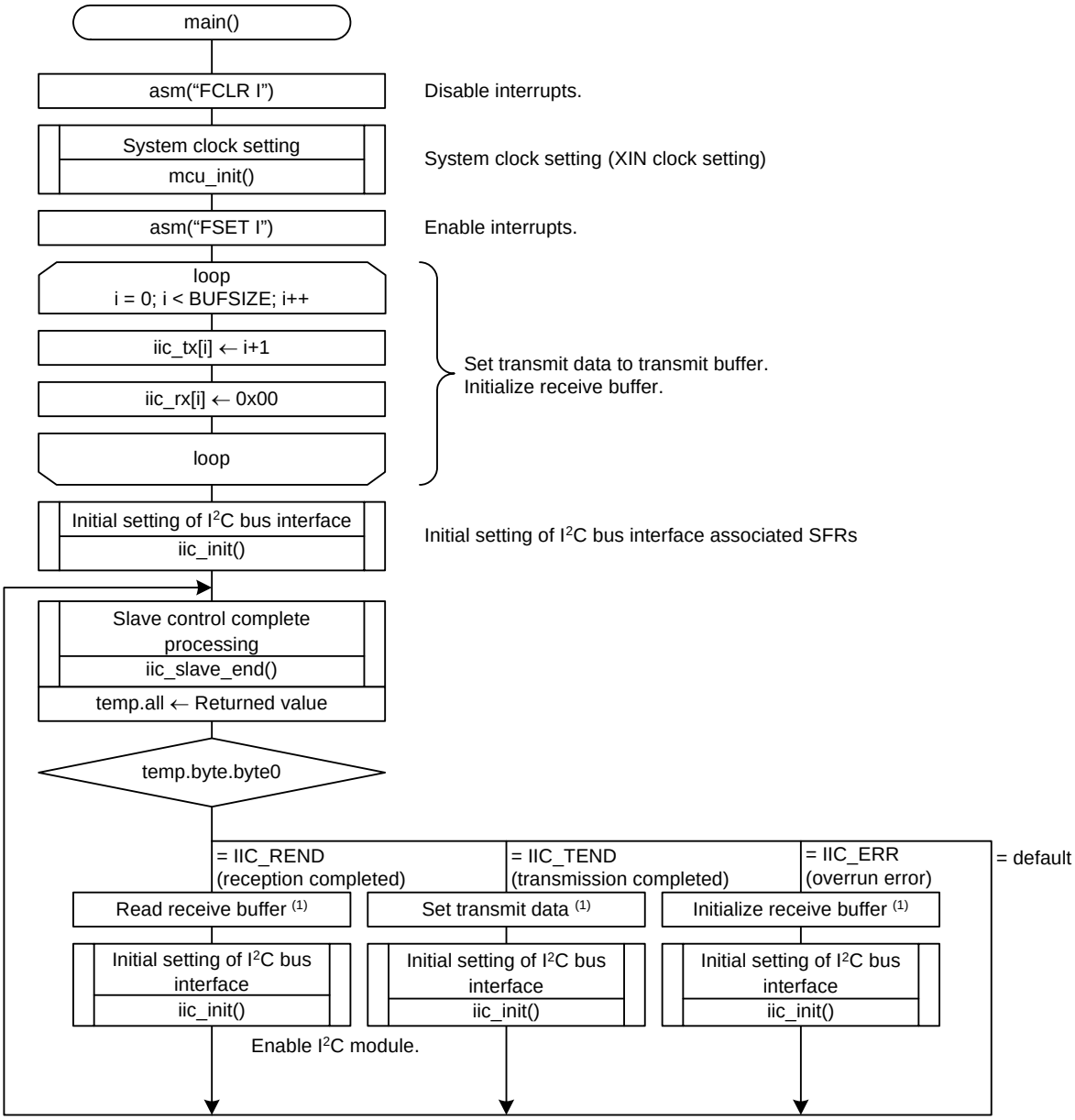
Declaration	static void stp_int(void)		
Outline	Stop condition detection processing		
Argument	Argument name		Meaning
	None		—
Variable (global)	Variable name		Contents
	(Structure member) iic_end		Communication end flag
Returned value	Type	Value	Meaning
	None	—	—
Function	This function is called from the I2C bus interface interrupt handling. Reset the I2C bus interface associated SFRs changed during communication and set the communication end flag to 1.		

Declaration	static void slave_rcv_int(void)		
Outline	Slave receive processing		
Argument	Argument name		Meaning
	None		—
Variable (global)	Variable name		Contents
	unsigned char iic_index		Number of transmit/receive bytes
	unsigned char far *iic_pointer		Transmit/receive buffer pointer
	(Structure member) iic_buf_full		Buffer full flag
Returned value	Type	Value	Meaning
	None	—	—
Function	This function is called from the I2C bus interface interrupt handling. • When the number of receive bytes has not reached the buffer size, store the received data to the receive buffer (not the slave address). • When the number of receive bytes has reached the buffer size, store the received data to the receive buffer and set the buffer full flag to 1. • When the number of receive bytes is greater than the buffer size, discard the received data.		

Declaration	static void slave_trn_int(void)		
Outline	Slave transmit processing		
Argument	Argument name		Meaning
	None		—
Variable (global)	Variable name		Contents
	unsigned char iic_index		Number of transmit/receive bytes
	unsigned char far *iic_pointer		Transmit/receive buffer pointer
	(structure member) iic_buf_full		Buffer full flag
	(structure member) iic_nack_det		NACK detection flag
Returned value	Type	Value	Meaning
	None	—	—
Function	This function is called from the I2C bus interface interrupt handling. • When the number of transmit bytes has not reached the buffer size and ACK is detected, set the transmit data for the next byte. • When the number of transmit bytes has not reached the buffer size and NACK is detected, set to slave receive mode. Disable the transmit end interrupt request and enable the receive data full interrupt request. Set the NACK detection flag to 1. • When the number of transmit bytes has reached the buffer size, set to slave receive mode. Disable the transmit end interrupt request and enable the receive data full interrupt request. Set the buffer full flag to 1. • When the NACK detection error flag is 1 or the buffer full flag is 1, discard the received data.		

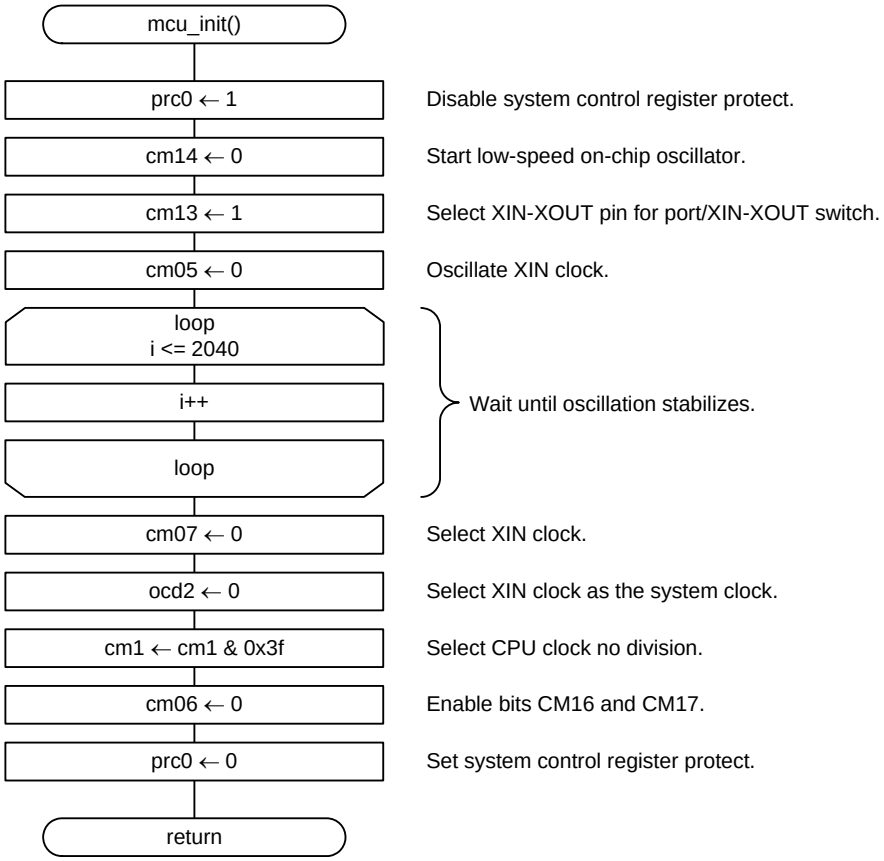
<table>
<tr><td>Declaration</td><td colspan="4">unsigned short iic_slave_end(void)</td></tr>
<tr><td>Outline</td><td colspan="4">Slave control complete processing</td></tr>
<tr><td rowspan="2">Argument</td><td colspan="3">Argument name</td><td>Meaning</td></tr>
<tr><td colspan="3">None</td><td>—</td></tr>
<tr><td rowspan="5">Variable (global)</td><td colspan="3">Variable name</td><td>Contents</td></tr>
<tr><td colspan="3">(Structure member) iic_end</td><td>Communication end flag</td></tr>
<tr><td colspan="3">(Structure member) iic_buf_full</td><td>Buffer full flag</td></tr>
<tr><td colspan="3">(Structure member) iic_rw</td><td>R/$\overline{W}$ flag</td></tr>
<tr><td colspan="3">unsigned char iic_index</td><td>Number of transmit/receive bytes</td></tr>
<tr><td rowspan="6">Returned value</td><td colspan="2">Type</td><td>Value</td><td>Meaning</td></tr>
<tr><td rowspan="5">unsigned short</td><td rowspan="4">Low-order byte</td><td>IIC_BUSY</td><td>Mid-communication</td></tr>
<tr><td>IIC_REND</td><td>Reception completed</td></tr>
<tr><td>IIC_TEND</td><td>Transmission completed</td></tr>
<tr><td>IIC_ERR</td><td>Overrun error detected</td></tr>
<tr><td>High-order byte</td><td>1 to 255</td><td>Number of transmit/receive bytes</td></tr>
<tr><td>Function</td><td colspan="4">This function is called from the main processing and informs the user of the slave control complete state. When the communication end flag is 1 and data excluding the slave address is transmitted or received, disable the I²C module. Otherwise return IIC_BUSY (mid-communication). When the communication end flag is 0 after disabling the I²C module, determine when the next communication starts and return IIC_ERR (overrun error detected). When the communication end flag is 1, return IIC_REND (reception completed) or IIC_TEND (transmission completed).</td></tr>
</table>

4.3 Main Processing

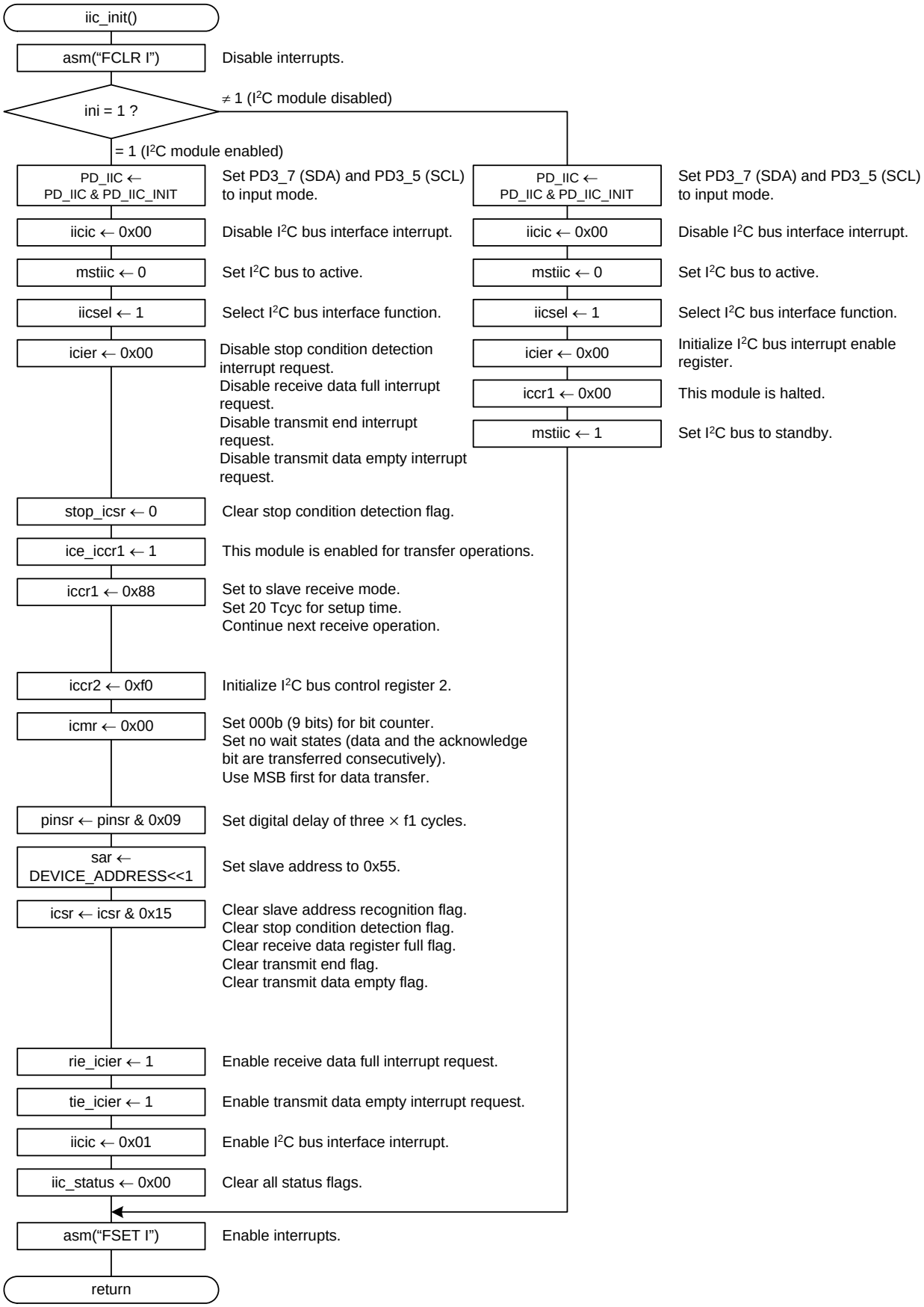


Note:
1. Additional processing can be added as needed.

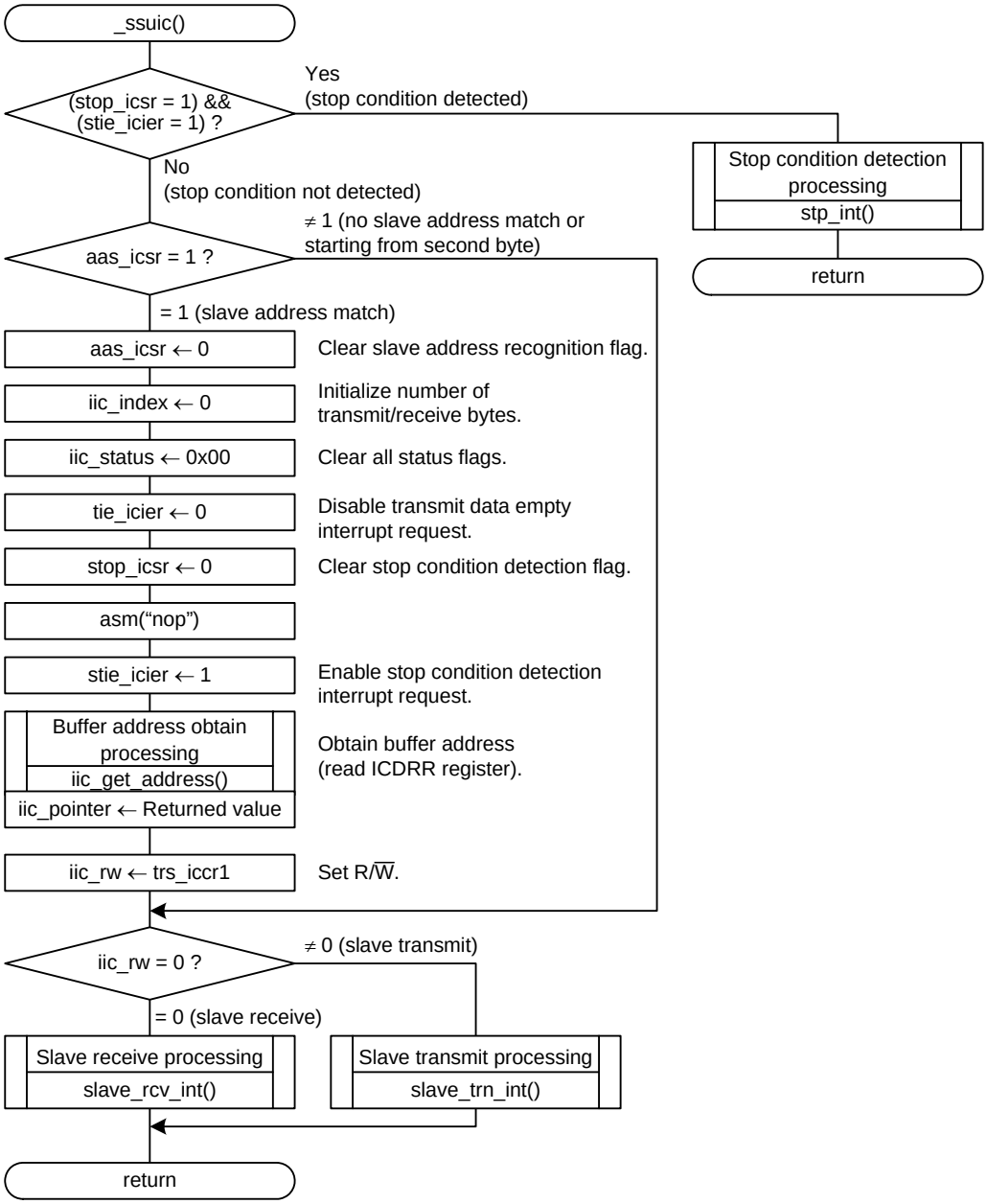
4.4 System Clock Setting



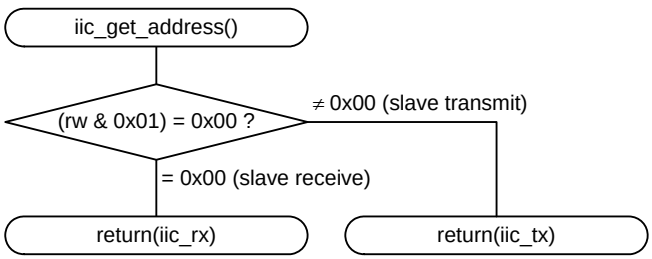
4.5 Initial Setting of I²C bus Interface



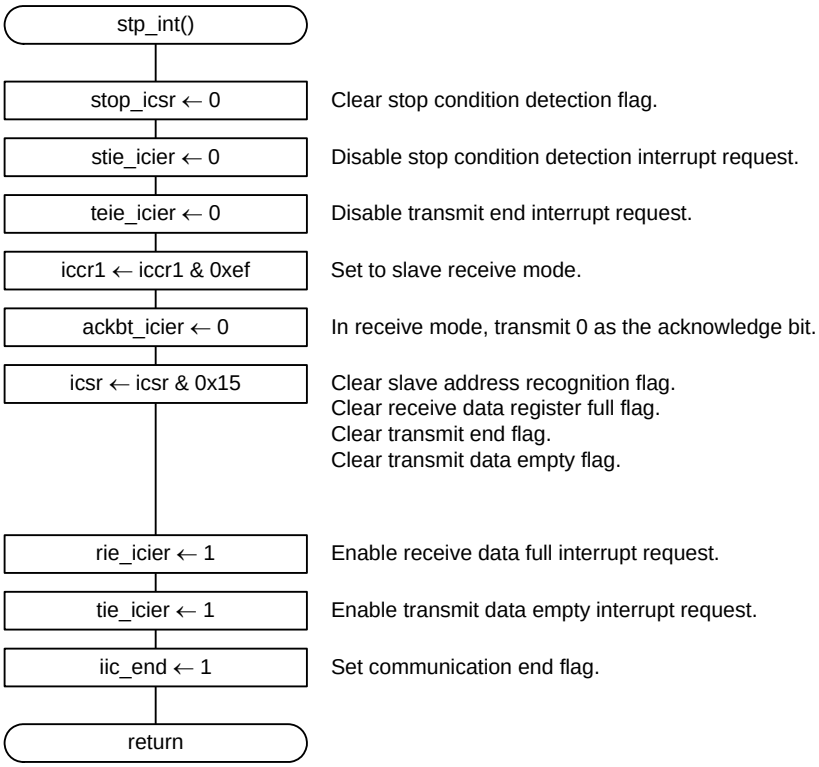
4.6 I²C bus Interface Interrupt Handling



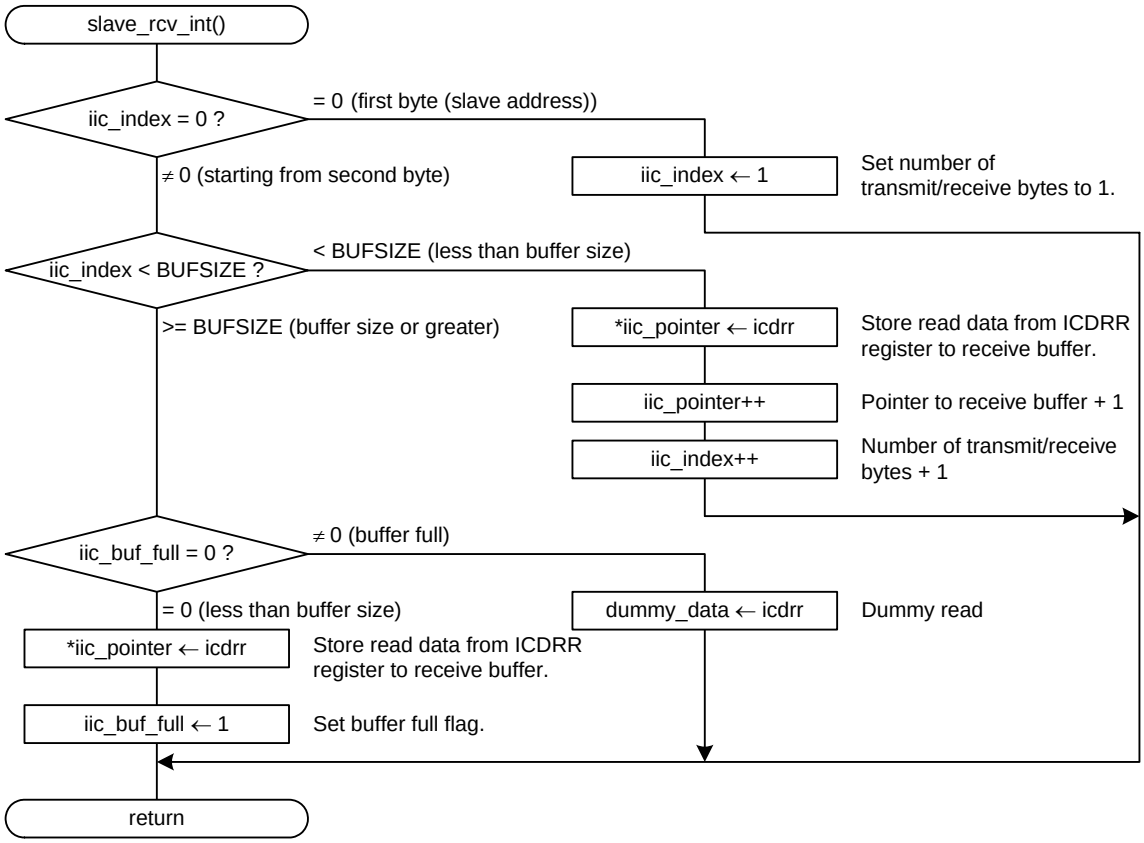
4.7 Obtain Buffer Address Processing



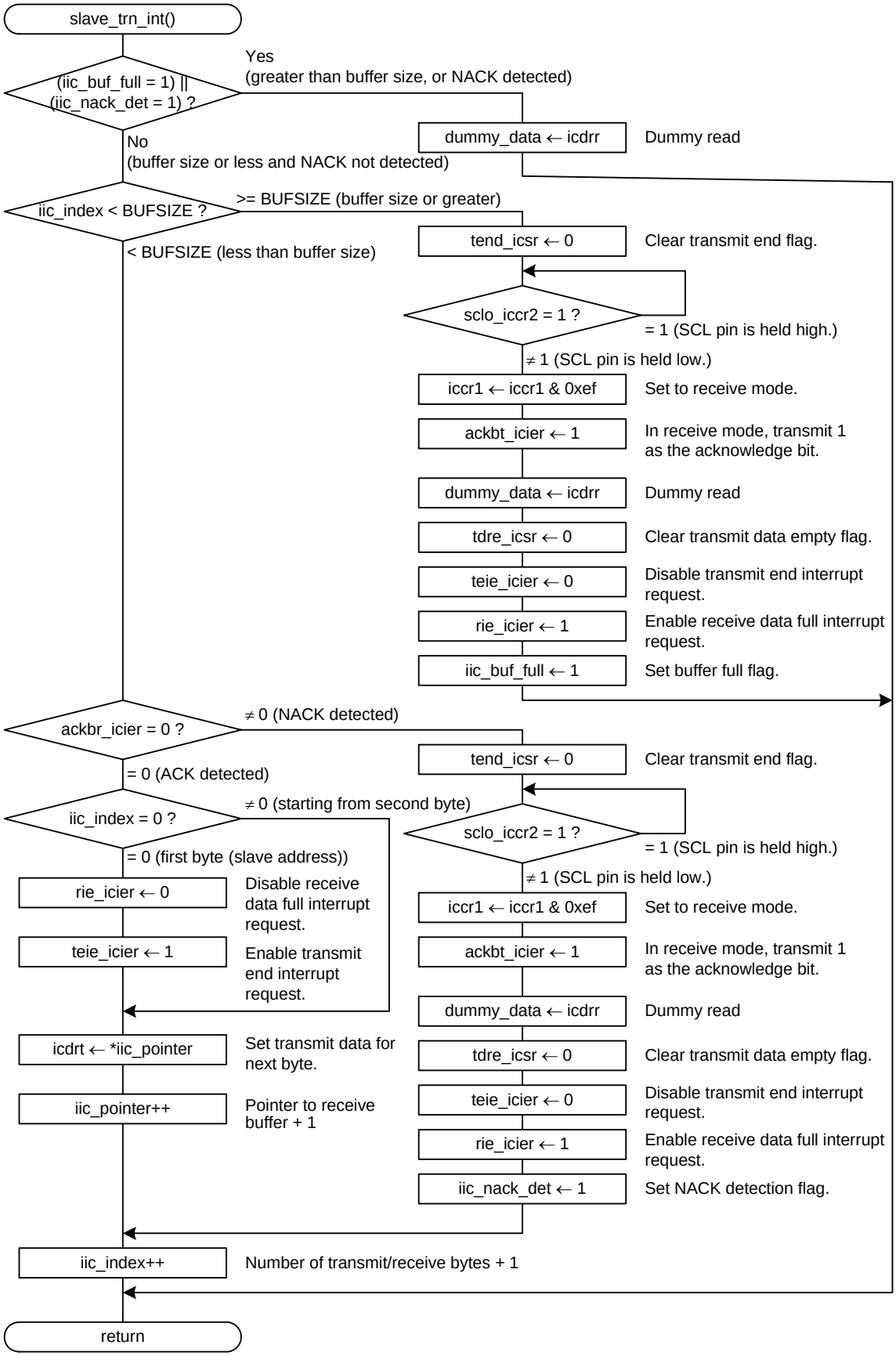
4.8 Stop Condition Detection Processing



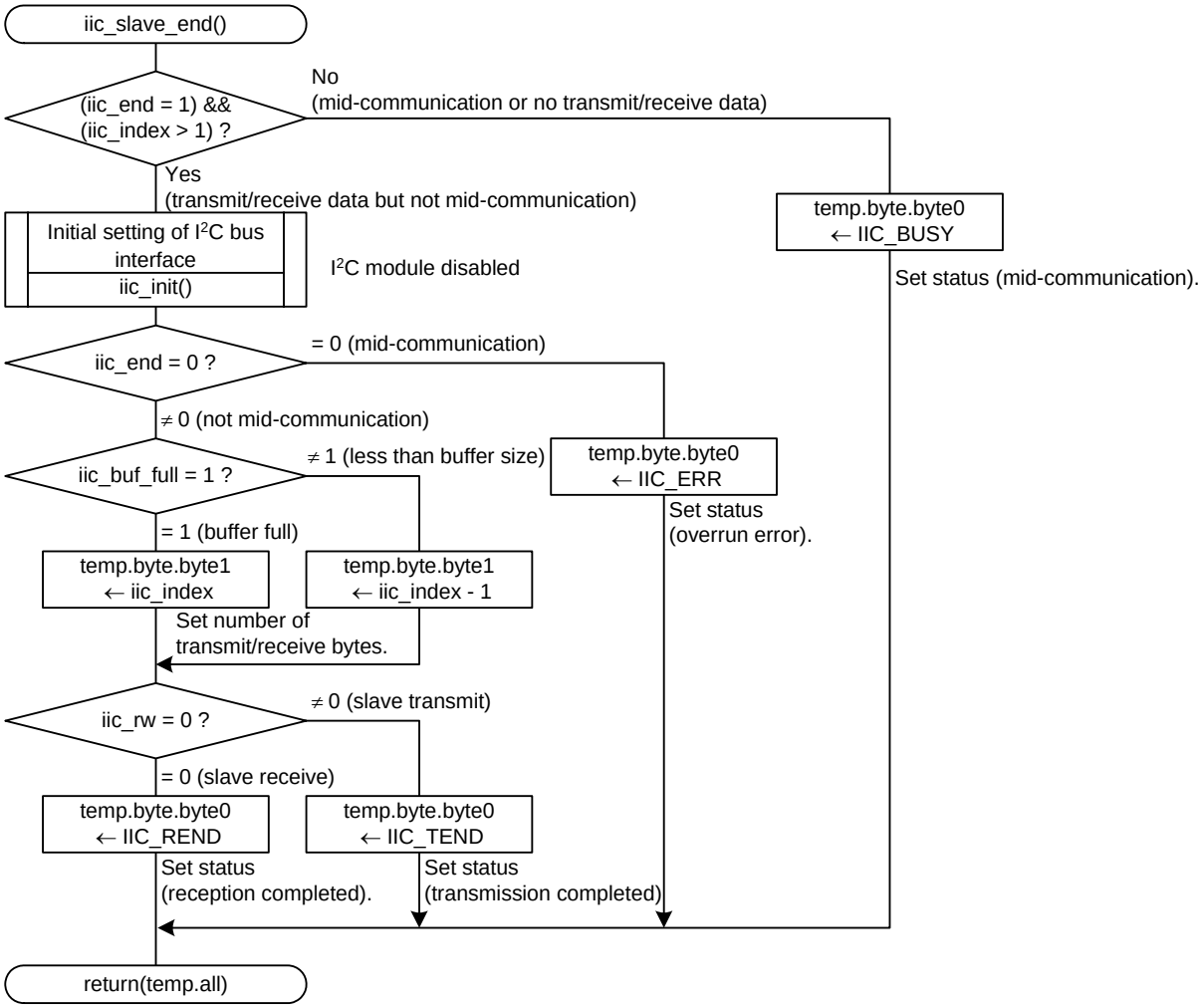
4.9 Slave Receive Processing



4.10 Slave Transmit Processing



4.11 Slave Control Complete Processing



5. Sample Program

A sample program can be downloaded from the Renesas Electronics website.
To download, click “Application Notes” in the left-hand side menu of the R8C Family page.

6. Reference Documents

R8C/35C Group User’s Manual: Hardware Rev.1.00
The latest version can be downloaded from the Renesas Electronics website.

Technical Update/Technical News
The latest information can be downloaded from the Renesas Electronics website.

Website and Support

Renesas Electronics website
http://www.renesas.com/

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Revision History	R8C/35C Group I²C bus Single Master Control Program (Slave Transmit/Receive)

Rev.	Date	Description	
		Page	Summary
1.00	Aug. 31, 2010	—	First edition issued

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

1. Handling of Unused Pins

   Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual.

   — The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

   The state of the product is undefined at the moment when power is supplied.

   — The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

   In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

   In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

   Access to reserved addresses is prohibited.

   — The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

   After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

   — When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

   Before changing from one product to another, i.e. to one with a different part number, confirm that the change will not lead to problems.

   — The characteristics of MPU/MCU in the same group but having different part numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different part numbers, implement a system-evaluation test for each of the products.

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